



CERAMIC BALUN

RF Transformer

TCW2-282+

50Ω 700 to 2800 MHz 1:2 Ratio

FEATURES

- Wideband, 700 to 2800 MHz
- Miniature Size 0603 (1.6x0.8 mm)
- LTCC Construction
- Low Cost
- Aqueous Washable



Generic photo used for illustration purposes only

CASE STYLE: JC0603C

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- WLAN
- A/D Conversion
- WiFi
- Transmitters and Receivers
- Cellular

ELECTRICAL SPECIFICATIONS¹ AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (Secondary/Primary)			2		
Frequency Range		700		2800	MHz
Avg. Insertion Loss ²	700-2800		1.2	2.0	dB
Amplitude Unbalance	700-2800		1	2	dB
Phase Unbalance ³	700-2800		13	16	Degree

1. In Applications where DC voltage is present at either Secondary port and DC feeding is not intended, a DC blocking capacitor is required between Pin 2 and GND. Pin 2 and Pin 5 should not be shorted on the PCB in this case.

2. Reference demo board TB-TCW2-282+.

3. Relative to 180°.

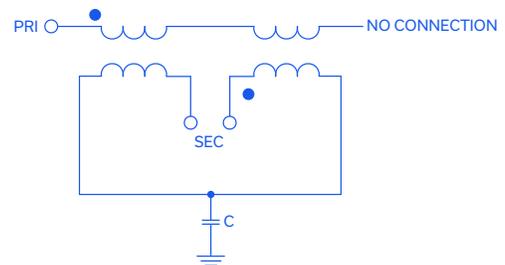
ABSOLUTE MAXIMUM RATINGS

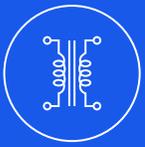
Parameter	Ratings
Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input ⁴	0.5 W at +25°C

4. Passband rating.

Permanent damage may occur if any of these limits are exceeded.

CONFIGURATION R





CERAMIC BALUN

RF Transformer

TCW2-282+

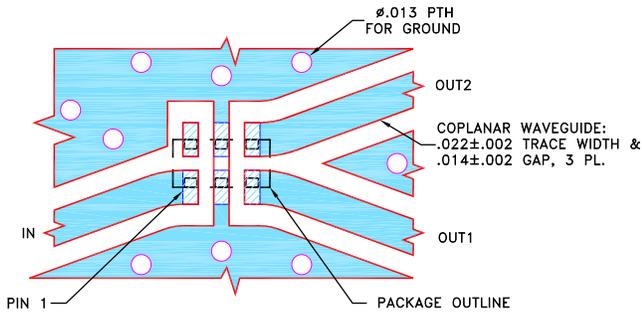
50Ω 700 to 2800 MHz 1:2 Ratio

PAD CONNECTIONS

PRIMARY DOT (Unbalanced Port)	1
GND or DC Feed + RF GROUND	2
SECONDARY DOT (Balanced)	3
SECONDARY (Balanced)	4
NO CONNECTION	6
RF GROUND	5

PRODUCT MARKING: N/A

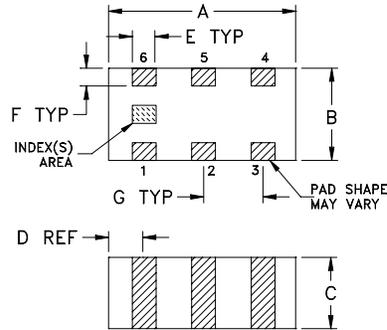
DEMO BOARD MCL P/N: TB-TCW2-282+ SUGGESTED PCB LAYOUT (PL-513)



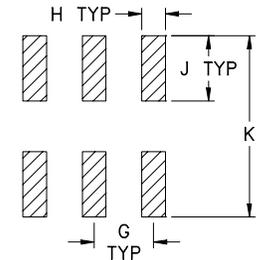
- TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS $.010 \pm .001$ ". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

OUTLINE DIMENSIONS (Inches) mm

A	B	C	D	E	F
.063	.031	.024	.012	.008	.006
1.60	0.79	0.61	0.30	0.20	0.15
G	H	J	K	wt	
.020	.010	.022	.053	grams	
0.51	0.25	0.56	1.35	0.005	

TAPE & REEL INFORMATION: F114



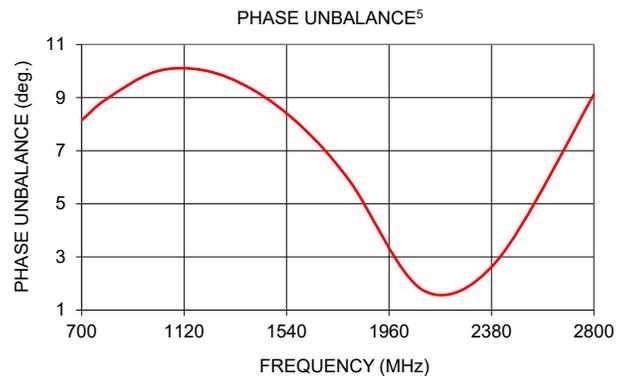
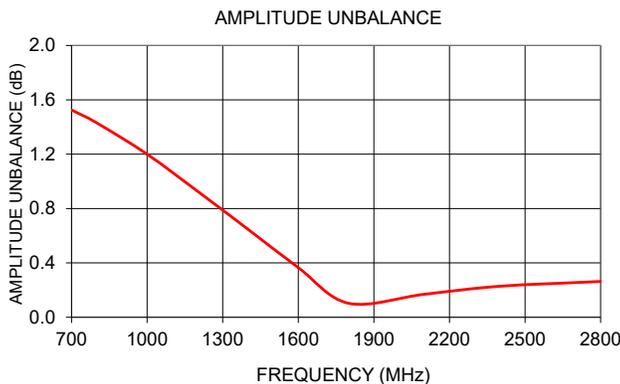
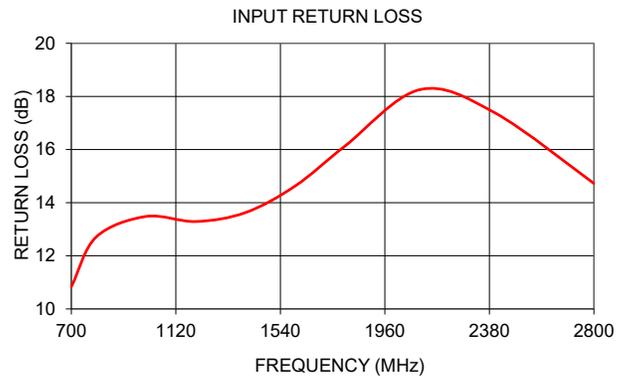


TYPICAL PERFORMANCE DATA⁵

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance ⁶ (deg)
700	4.13	10.83	1.53	8.14
800	3.95	12.71	1.43	8.93
1000	3.88	13.48	1.20	9.97
1200	3.90	13.29	0.93	10.03
1400	3.92	13.63	0.65	9.31
1600	3.93	14.63	0.37	7.93
1800	3.92	16.13	0.10	5.85
2100	3.92	18.25	0.17	1.75
2400	3.97	17.39	0.23	2.83
2800	4.10	14.72	0.26	9.13

5. Measured with Agilent E5071B network analyzer using impedance conversion and port extension.

6. Relative to 180°.



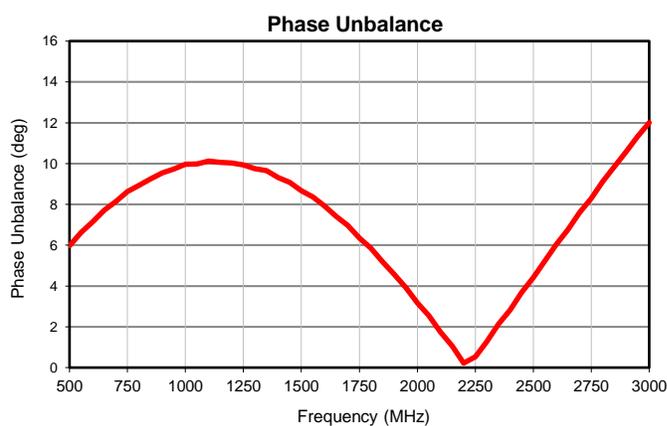
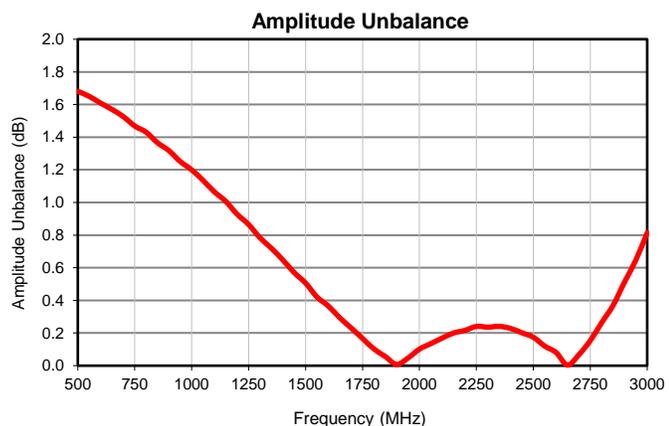
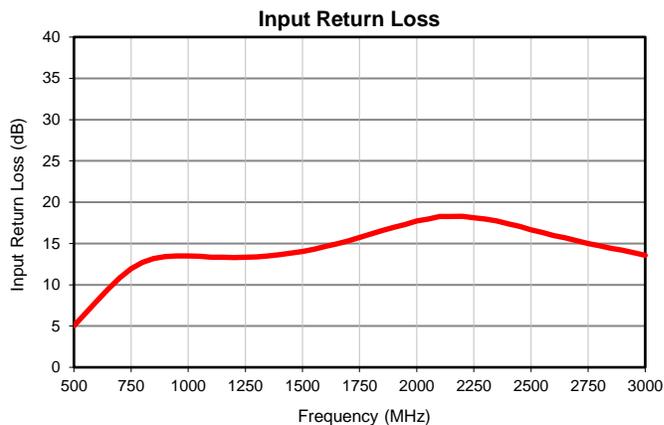
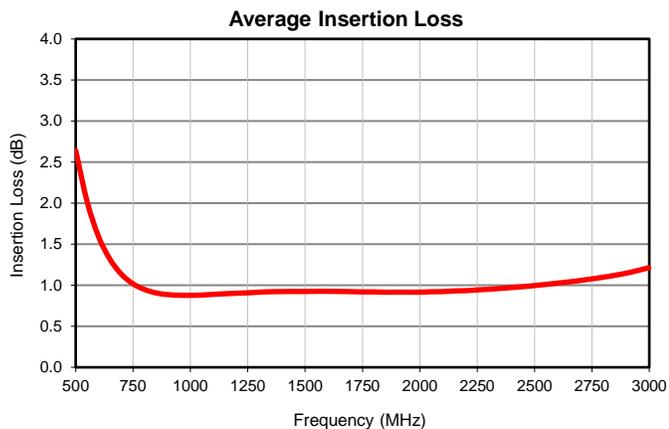
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Typical Performance Data

FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
500	2.64	5.03	1.68	5.97
550	2.01	6.50	1.65	6.63
600	1.59	8.01	1.61	7.14
650	1.31	9.49	1.57	7.72
700	1.13	10.83	1.53	8.14
750	1.02	11.93	1.47	8.63
800	0.95	12.71	1.43	8.93
850	0.91	13.18	1.37	9.24
900	0.89	13.42	1.32	9.54
950	0.88	13.49	1.25	9.73
1000	0.88	13.48	1.20	9.97
1050	0.88	13.43	1.13	9.98
1100	0.89	13.34	1.06	10.13
1150	0.90	13.32	1.01	10.05
1200	0.90	13.29	0.93	10.03
1250	0.91	13.34	0.87	9.93
1300	0.92	13.38	0.78	9.75
1350	0.92	13.49	0.72	9.66
1400	0.92	13.63	0.65	9.31
1450	0.92	13.82	0.57	9.08
1500	0.92	14.04	0.51	8.68
1550	0.93	14.31	0.42	8.35
1600	0.93	14.63	0.37	7.93
1650	0.92	14.94	0.29	7.40
1700	0.92	15.31	0.23	6.97
1750	0.92	15.71	0.17	6.35
1800	0.92	16.13	0.10	5.85
1850	0.92	16.56	0.06	5.19
1900	0.92	16.97	0.01	4.57
1950	0.92	17.32	0.05	3.93
2000	0.92	17.71	0.10	3.17
2050	0.92	17.95	0.14	2.55
2100	0.92	18.25	0.17	1.75
2150	0.93	18.25	0.20	1.06
2200	0.93	18.29	0.22	0.22
2250	0.94	18.11	0.24	0.53
2300	0.95	17.97	0.24	1.28
2350	0.96	17.73	0.24	2.12
2400	0.97	17.39	0.23	2.83
2450	0.98	17.07	0.20	3.69
2500	1.00	16.63	0.17	4.41
2550	1.01	16.33	0.12	5.22
2600	1.03	15.96	0.08	6.03
2650	1.04	15.69	0.00	6.77
2700	1.06	15.34	0.07	7.60
2750	1.08	15.01	0.15	8.30
2800	1.10	14.72	0.26	9.13
2850	1.12	14.42	0.37	9.84
2900	1.15	14.20	0.51	10.58
2950	1.18	13.86	0.65	11.32
3000	1.21	13.57	0.81	12.00

Typical Performance Data

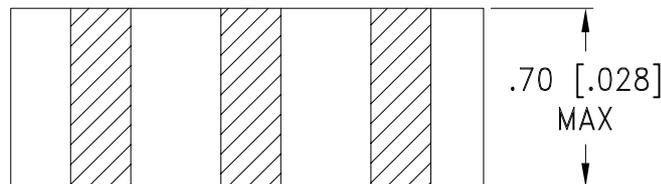
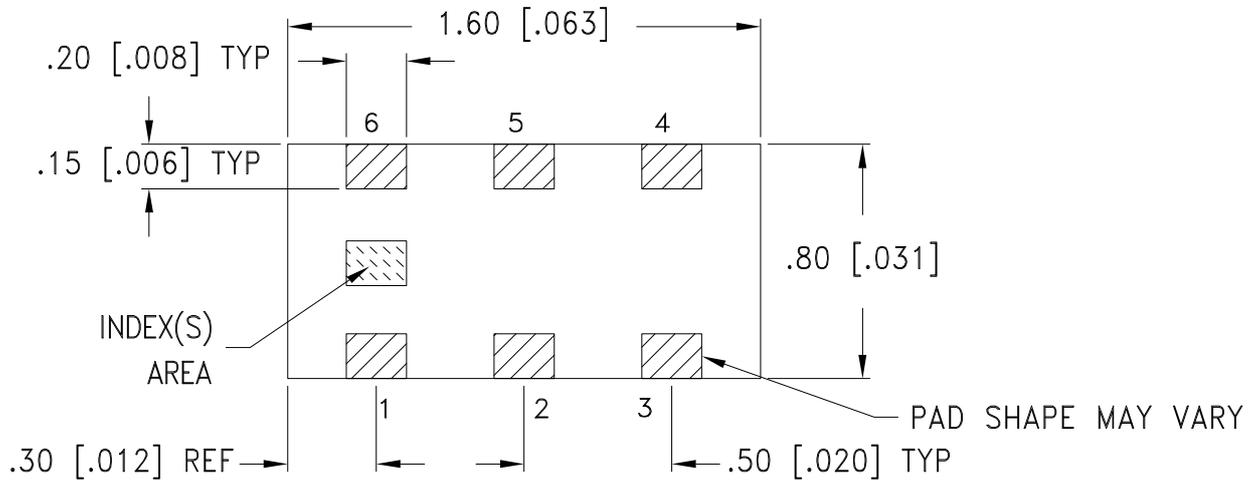


Case Style

JC

Outline Dimensions

JC0603C



Weight: .005 grams

Dimensions are in mm [inch]. Tolerances: ± 0.13 mm

Notes:

1. Open style, ceramic base.
2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

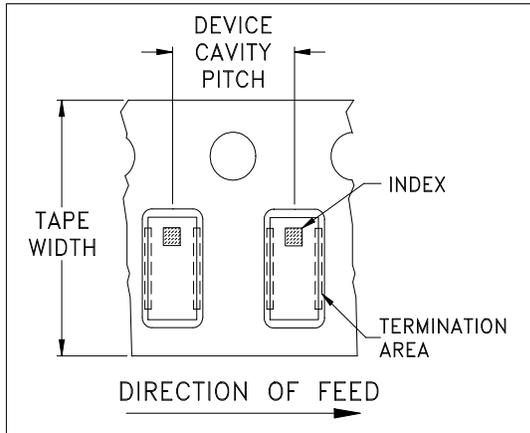


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

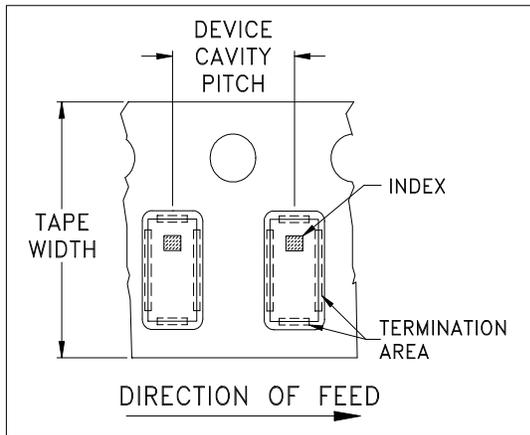


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



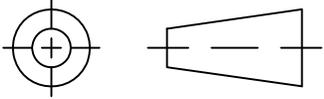
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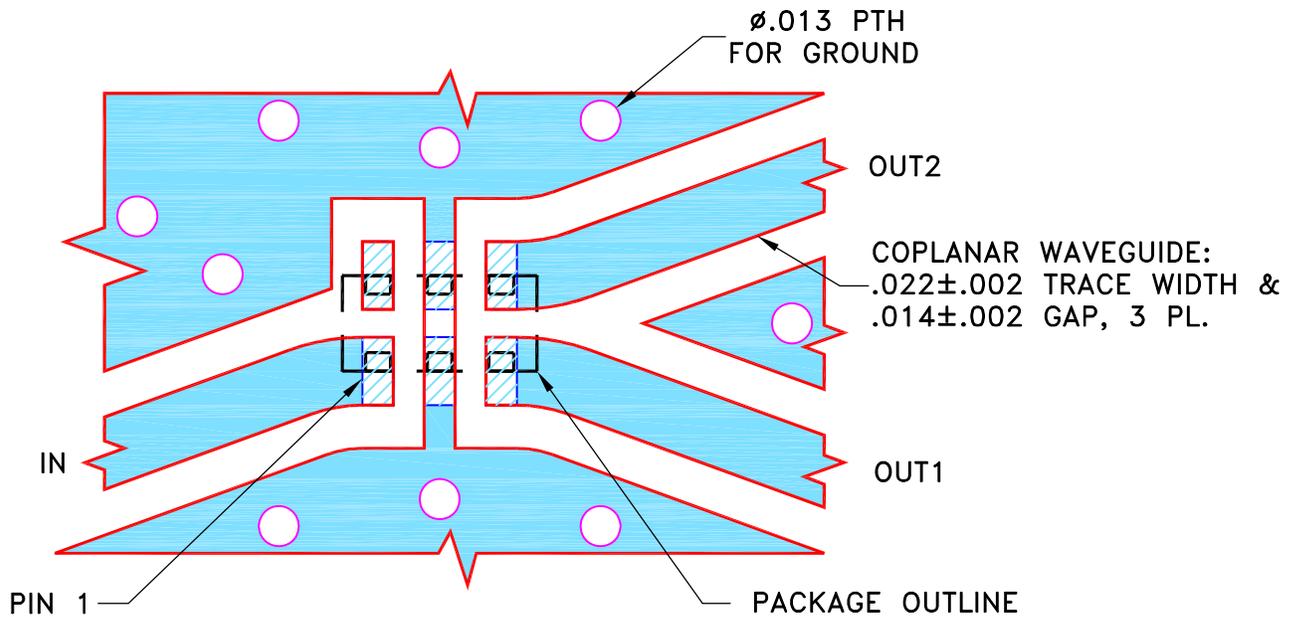
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M162337	NEW RELEASE	06/15/17	ITG	AVB

**SUGGESTED MOUNTING CONFIGURATION
FOR JC0603C CASE STYLE, "06TR01" PIN CODE**



- TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $.010 \pm .001$ ". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	ITG	06/14/17
	CHECKED	GF	06/15/17
	APPROVED	AVB	06/15/17

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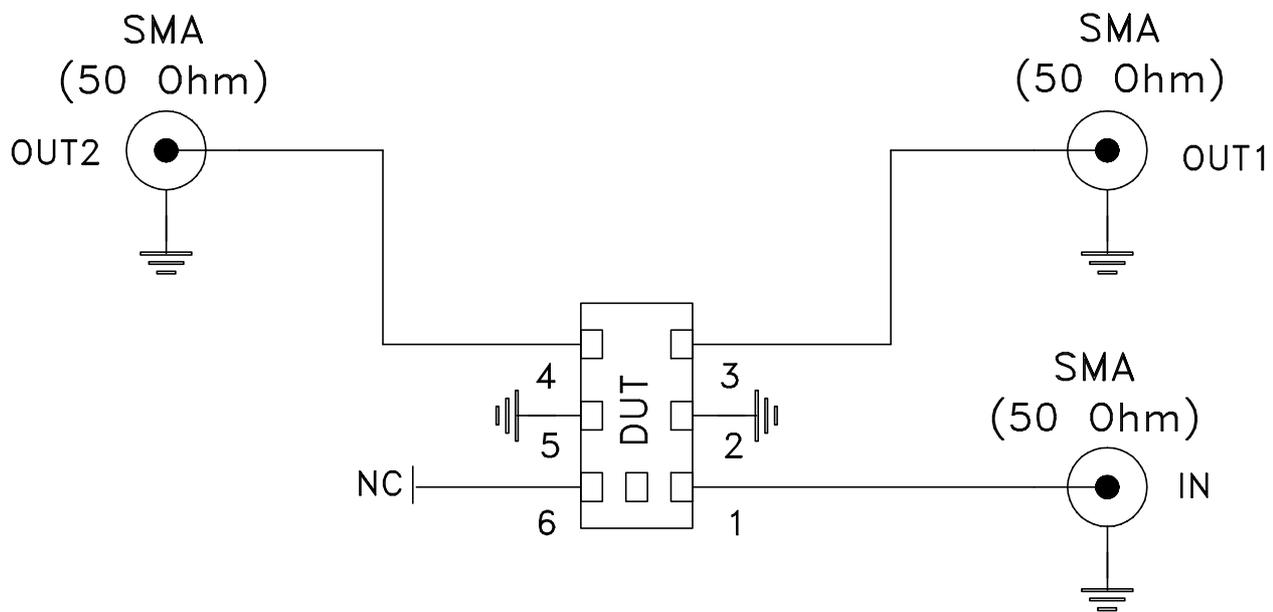
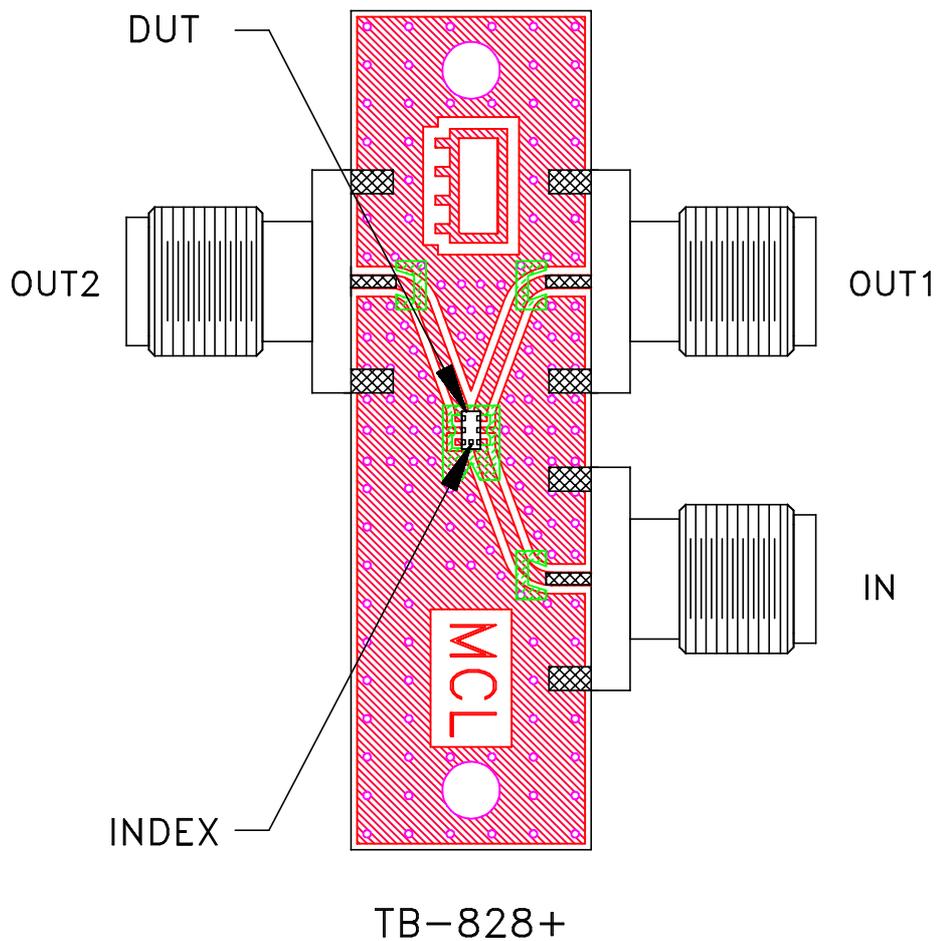
PL, 06TR01, JC0603C, TB-828+

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ASHEETA1.DWG REV:A DATE:01/12/95

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-513	OR
FILE:	98PL513	SCALE: 16:1	SHEET: 1 OF 1

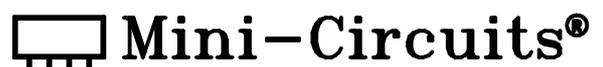
Evaluation Board and Circuit



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.010 inch.



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A